MOSFET - Small Signal, Complementary, SOT-963, 1.0 x 1.0 mm

20 V, 220 mA / -200 mA

Features

- Complementary MOSFET Device
- Offers a Low R_{DS(on)} Solution in the Ultra Small 1.0x1.0 mm Package
- 1.5 V Gate Voltage Rating
- Ultra Thin Profile (< 0.5 mm) Allows It to Fit Easily into Extremely Thin Environments such as Portable Electronics.
- This is a Pb-Free Device

Applications

- Load Switch with Level Shift
- Optimized for Power Management in Ultra Portable Equipment

MAXIMUM RATINGS (T, I = 25°C unless otherwise specified)

Para	Symbol	Value	Unit			
Drain-to-Source Voltaç	V_{DSS}	20	V			
Gate-to-Source Voltag	е		V _{GS}	±8	V	
N-Channel	Steady	$T_A = 25^{\circ}C$		220		
Continuous Drain Current (Note 1)	State	$T_A = 85^{\circ}C$		160		
	t ≤ 5 s	$T_A = 25^{\circ}C$		280	mA	
P-Channel	Steady	T _A = 25°C	I _D	-200		
Continuous Drain Current (Note 1)	State T _A	$T_A = 85^{\circ}C$		-140		
	t ≤ 5 s	$T_A = 25^{\circ}C$		-250		
Power Dissipation	Steady	T _A = 25°C	P _D	125		
(Note 1)	State T _A =				mW	
	t ≤ 5 s			200		
Pulsed Drain Current	N-Channel	t _p = 10 μs	I _{DM}	800	mA	
	MU	-600	ША			
Operating Junction and	T _J ,	-55 to	°C			
	T _{STG}	150				
Source Current (Body [I _S	200	mA			
Lead Temperature for S (1/8" from case for 1	TL	260	°C			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz. Cu.
- 2. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%

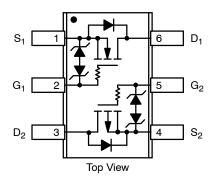


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(on)} Max	I _D Max
	1.5 Ω @ 4.5 V	
N-Channel	2.0 Ω @ 2.5 V	
20 V	3.0 Ω @ 1.8 V	0.22 A
	4.5 Ω @ 1.5 V	
	5.0 Ω @ -4.5 V	
P-Channel 20 V	6.0 Ω @ -2.5 V	-0.2 A
	7.0 Ω @ –1.8 V	-0.2 A
	10 Ω @ -1.5 V	

PINOUT: SOT-963





SOT-963 CASE 527AD

MARKING DIAGRAM



2 = Specific Device Code = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NTUD3169CZT5G	SOT-963 (Pb-Free)	8000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State, Minimum Pad (Note 3)	$R_{ heta JA}$	1000	°C/W
Junction-to-Ambient - t ≤ 5 s (Note 3)		600	

^{3.} Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz. Cu.

ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise specified)

Parameter	Symbol	N/P	Test Condition	on	Min	Тур	Max	Unit
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage		N			20			
	$V_{(BR)DSS}$	Р	$V_{GS} = 0 V$	I _D = -250 μA	-20			V
Zero Gate Voltage Drain Current				T _J = 25°C			50	
		N	$V_{GS} = 0 \text{ V}, V_{DS} = 5.0 \text{ V}$	T _J = 85°C			200	
	I _{DSS}		T _J = 25°C			-50	nA	
		Р	$V_{GS} = 0 \text{ V}, V_{DS} = -5.0 \text{ V}$	T _J = 85°C			-200	
Zero Gate Voltage Drain Current		N	V _{GS} = 0 V, V _{DS} = 16 V				100	
	I _{DSS}	Р	$V_{GS} = 0 \text{ V}, V_{DS} = -16 \text{ V}$	T _J = 25°C			-100	nA
Gate-to-Source Leakage Current		N	V 0VV	15.01/			±100	
	I _{GSS}	Р	$V_{DS} = 0 \text{ V}, V_{GS} =$	±5.0 V			±100	nA
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	M	N	$V_{GS} = V_{DS}$	$I_D = 250 \mu\text{A}$			1.0	V
	$V_{GS(TH)}$	Р		$I_D = -250 \mu A$	-0.4		-1.0	
Drain-to-Source On Resistance	R _{DS(on)}	N	V_{GS} = 4.5 V, I_D =	100 mA		0.75	1.5	
		Р	$V_{GS} = -4.5V$, $I_D = -100 \text{ mA}$			2.0	5.0	Ω
		N	V _{GS} = 2.5 V, I _D = 50 mA			1.0	2.0	
		Р	$V_{GS} = -2.5V$, $I_D = -50$ mA			2.6	6.0	
		N	$V_{GS} = 1.8 \text{ V}, I_D = 20 \text{ mA}$			1.4	3.0	
		Р	$V_{GS} = -1.8V$, $I_D = -20$ mA			3.4	7.0	
		N	$V_{GS} = 1.5 \text{ V}, I_D = 10 \text{ mA}$			1.8	4.5	
		Р	$V_{GS} = -1.5 \text{ V}, I_D =$	–10 mA		4.0	10	
		N	V_{GS} = 1.2 V, I_D =	1.0 mA		2.8		
		Р	$V_{GS} = -1.2 \text{ V}, I_D =$	–1.0 mA		6.0		
Forward Transconductance	0	Ν	$V_{DS} = 5.0 \text{ V}, I_{D} = 3.0 \text{ V}$	125 mA		0.48		S
	9FS	Р	$V_{DS} = -5.0 \text{ V}, I_D = -6.0 \text{ V}$	-125 mA		0.35		
Source-Drain Diode Voltage	V_{SD}	N	$V_{GS} = 0 \text{ V, } I_{S} = 10 \text{ mA}$	$T_J = 25^{\circ}C$		0.6	1.0	V
		Р	V _{GS} = 0 V, I _S = -10 mA			-0.6	-1.0	
CAPACITANCES								
Input Capacitance	C_{ISS}		f = 1 MHz, V _{GS} = 0 V V _{DS} = 15 V			12.5		
Output Capacitance	C _{OSS}	N				3.6		
Reverse Transfer Capacitance	C _{RSS}					2.6		pF
Input Capacitance	C_{ISS}					13.5		
Output Capacitance	C _{OSS}	Р	f = 1 MHz, V _{GS} V _{DS} = -15 \	= 0 V V		3.8		
Reverse Transfer Capacitance	C _{RSS}		103 .5 .			2.0		

^{4.} Switching characteristics are independent of operating junction temperatures

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	N/P	Test Condition	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS, V _{GS} = 4.5 V (Note 4)							
Turn-On Delay Time	t _{d(ON)}	N	V_{GS} = 4.5 V, V_{DD} = 10 V, I_{D} = 200 mA, R_{G} = 2.0 Ω		16.5		
Rise Time	t _r				25.5		
Turn-Off Delay Time	t _{d(OFF)}				142		
Fall Time	t _f				80		
Turn-On Delay Time	t _{d(ON)}		V_{GS} = -4.5 V, V_{DD} = -15 V, I_{D} = -200 mA, R_{G} = 2.0 Ω		26		ns
Rise Time	t _r	P			46		
Turn-Off Delay Time	t _{d(OFF)}				196		
Fall Time	t _f				145		

^{4.} Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS (N-CHANNEL)

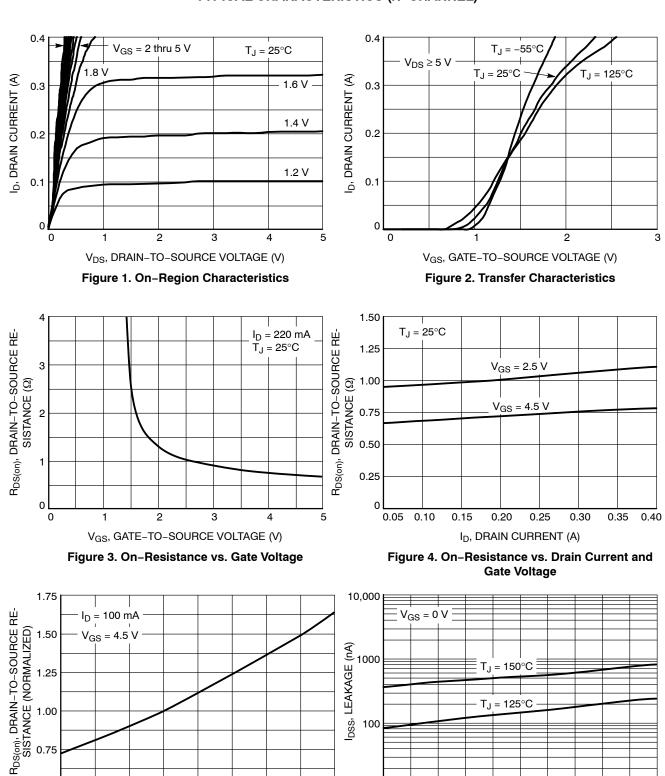


Figure 5. On-Resistance Variation with **Temperature**

T_J, JUNCTION TEMPERATURE (°C)

100

125

25

0.75

0.50

-50

-25

Figure 6. Drain-to-Source Leakage Current vs. Voltage

V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

20

150

10

0

TYPICAL CHARACTERISTICS (N-CHANNEL)

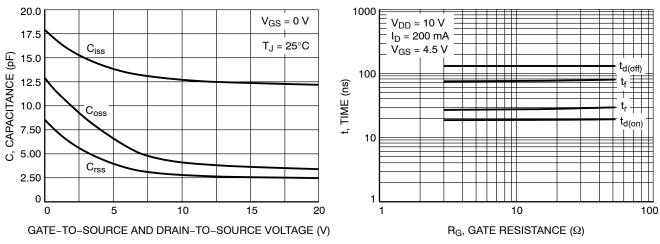


Figure 7. Capacitance Variation

Figure 8. Resistive Switching Time Variation vs. Gate Resistance

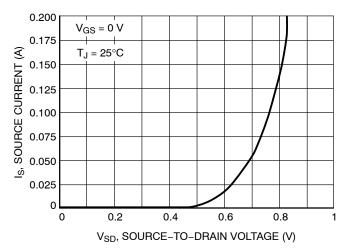


Figure 9. Diode Forward Voltage vs. Current

TYPICAL CHARACTERISTICS (P-CHANNEL)

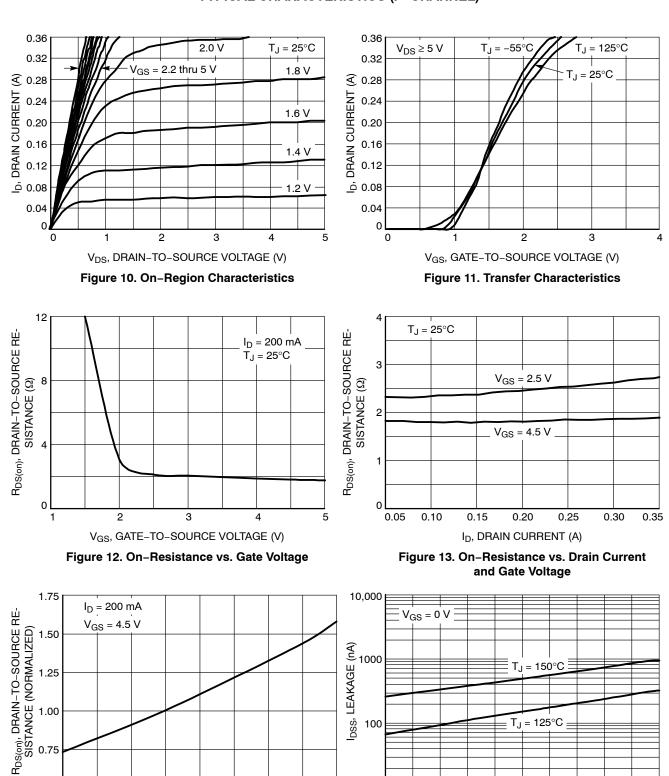


Figure 14. On–Resistance Variation with Temperature

50

T_J, JUNCTION TEMPERATURE (°C)

100

125

25

0.50

-50

-25

Figure 15. Drain-to-Source Leakage Current vs. Voltage

V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

20

150

10

TYPICAL CHARACTERISTICS (P-CHANNEL)

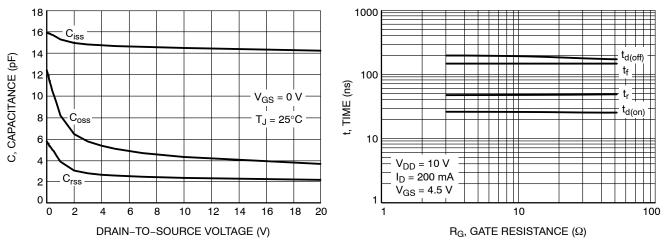


Figure 16. Capacitance Variation

Figure 17. Resistive Switching Time Variation vs. Gate Resistance

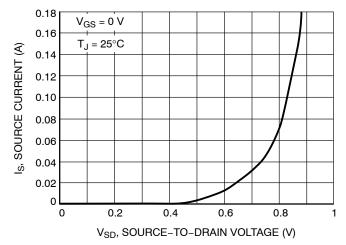
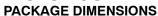


Figure 18. Diode Forward Voltage vs. Current





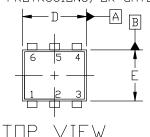


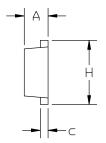
SOT-963 1.00x1.00x0.37, 0.35P CASE 527AD ISSUE F

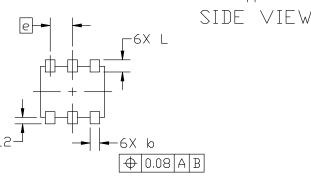
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NOTES:

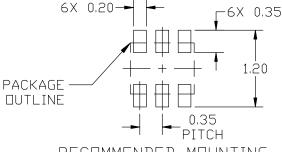
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.







MILLIMETERS DIM MIN. $N\square M$. MAX. 0.37 0.40 Α 0.34 0.10 0.15 0.20 h \subset 0.07 0.12 0.17 D 0.95 1.00 1.05 Ε 0.75 0.80 0.85 0.35 BSC 6 Н 1.00 0.95 1.05 0.19 REF L2 0.05 0.10 0.15



RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference manual, SDLDERRM/D.

BOTTOM VIEW

STYLE 1: PIN 1. EMITTER 1 2. BASE 1 3. COLLECTOR 2 4. EMITTER 2	STYLE 2: PIN 1. EMITTER 1 2. EMITTER2 3. BASE 2 4. COLLECTOR 2	STYLE 3: PIN 1. CATHODE 1 2. CATHODE 1 3. ANODE/ANODE 2 4. CATHODE 2
5. BASE 2 6. COLLECTOR 1	5. BASE 1 6. COLLECTOR 1	5. CATHODE 26. ANODE/ANODE 1
STYLE 4:	STYLE 5:	STYLE 6:

STYLE 4: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE

STYLE 7:
PIN 1. CATHODE
2. ANODE
3. CATHODE
4. CATHODE
5. ANODE
6. CATHODE
STYLE 10:
PIN 1. CATHODE 1
2. N/C
3. CATHODE 2

4. ANODE 2

6. ANODE 1

5. N/C

STYLE 5: PIN 1. CATHODE 2. CATHODE 3. ANODE 4. ANODE 5. CATHODE

5. CATHODE 5
6. CATHODE 6
STYLE 8: STYLE
PIN 1. DRAIN PIN 1
2. DRAIN 2
3. GATE 3
4. SOURCE 4
5. DRAIN 5
6. DRAIN 6

STYLE 6: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE

STYLE 9: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1 GENERIC
MARKING DIAGRAM*



XX = Specific Device CodeM = Month Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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